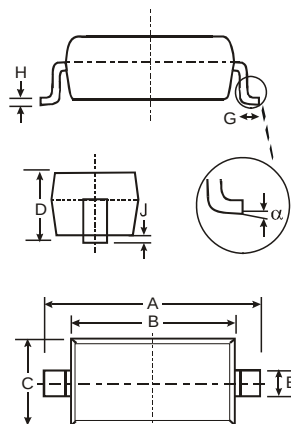


Features

- Low Forward Voltage Drop.
- Guard Ring Construction for Transient Protection.
- High Conductance.
- Also Available in Lead Free Version.

DEVICE	MARKING
B0520LW	B2
B0530W	B3
B0540W	B4



SOD-123		
Dim	Min	Max
A	3.55	3.85
B	2.55	2.85
C	1.40	1.70
D	—	1.35
E	0.45	0.65
	0.55 Typical	
G	0.25	—
H	0.11 Typical	
J	—	0.10
α	0°	8°
All Dimensions in mm		

Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

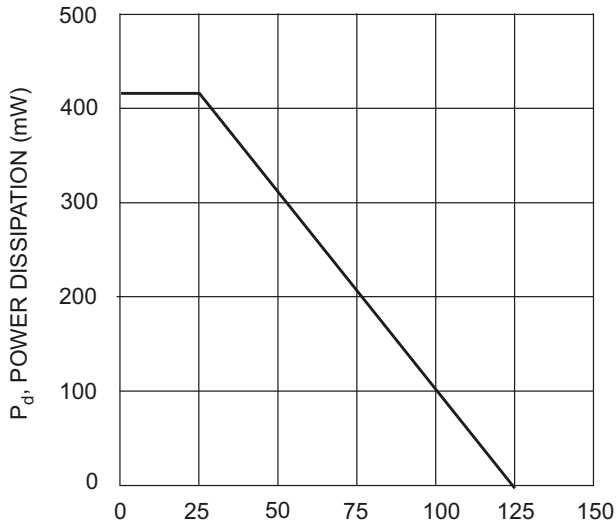
Parameter	Symbol	B0520LW	B0530W	B0540W	Unit
Peak Repetitive Peak Reverse Voltage	V_{RRM}				
Working Peak Reverse Voltage	V_{RWM}	20	30	40	V
DC Blocking Voltage	V_R				
RMS Reverse Voltage Reverse Voltage (DC)	$V_{R(RMS)}$	14	21	28	V
Average Rectified Output Current	I_O	0.5			A
Non-repetitive Peak Forward Surge Current @ $t=8.3\text{ms}$	I_{FSM}	5.5			A
Power Dissipation	P_D	500			mW
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	200			$^\circ\text{C/W}$
Junction Temperature	T_J	125			$^\circ\text{C}$
Storage Temperature	T_{STG}	-55~+150			$^\circ\text{C}$
Voltage Rate of Change	dv/dt	1000			V/ μs

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

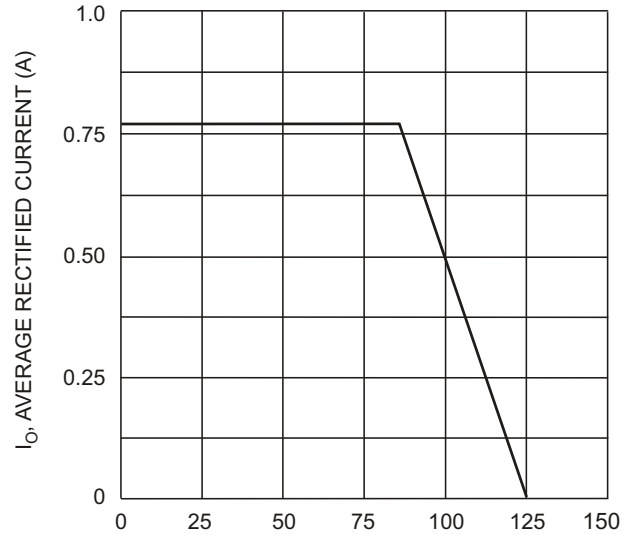
Parameter	Symbol	B0520LW	B0530W	B0540W	Unit	Test Conditions
Minimum reverse breakdown voltage	$V_{(BR)}$	20	--	--	V	$I_R=250\mu\text{A}$
		--	30	--		$I_R=200\mu\text{A}$
		--	--	40		$I_R=20\mu\text{A}$
Forward voltage	V_{F1}	0.32	0.375	--	V	$I_F=0.1\text{A}$
	V_{F2}	0.385	0.430	0.510		$I_F=0.5\text{A}$
	V_{F3}	--	--	0.62		$I_F=1\text{A}$
Reverse current	I_{R1}	75	--	--	μA	$V_R=10\text{V}$
	I_{R2}	--	20	--		$V_R=15\text{V}$
Reverse current	I_{R3}	250	--	10	μA	$V_R=20\text{V}$
	I_{R4}	--	130	--		$V_R=30\text{V}$
	I_{R5}	--	--	20		$V_R=40\text{V}$
Capacitance between terminals	C_T	--	--	170	pF	$V_R=0, f=1\text{MHz}$

TYPICAL TRANSIENT CHARACTERISTICS

B0520LW



T_A , AMBIENT TEMPERATURE (°C)
Fig. 1 Power Derating Curve



T_L , LEAD TEMPERATURE (°C)
Fig. 2 Forward Current Derating Curve

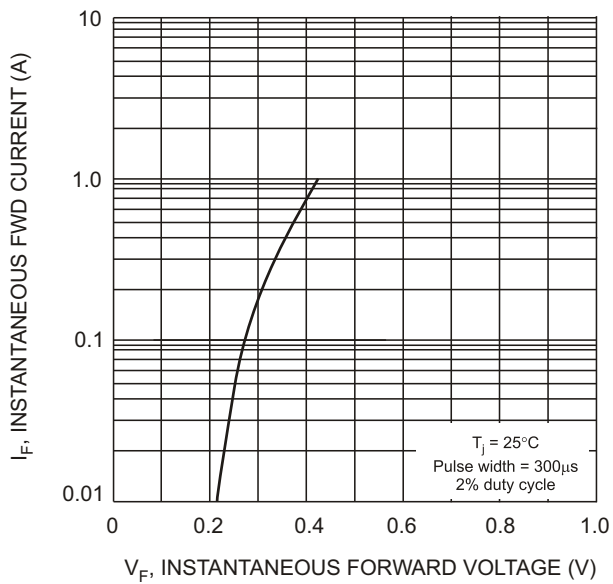


Fig. 3 Typical Forward Characteristics

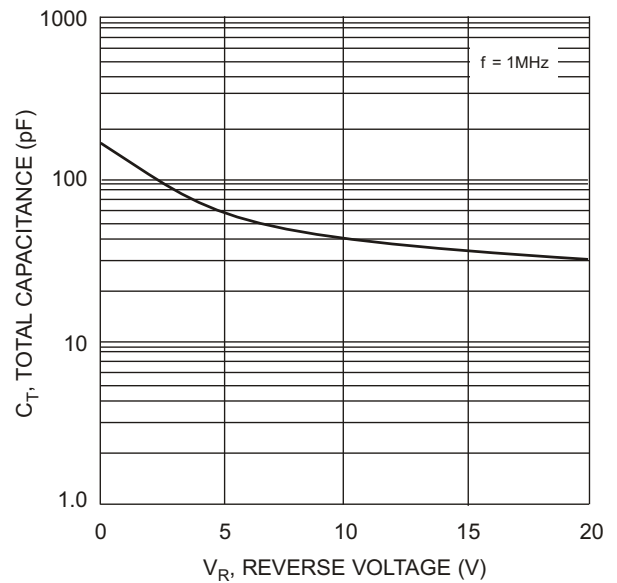


Fig. 4 Typ. Total Capacitance vs Reverse Voltage

TYPICAL TRANSIENT CHARACTERISTICS

B0530W

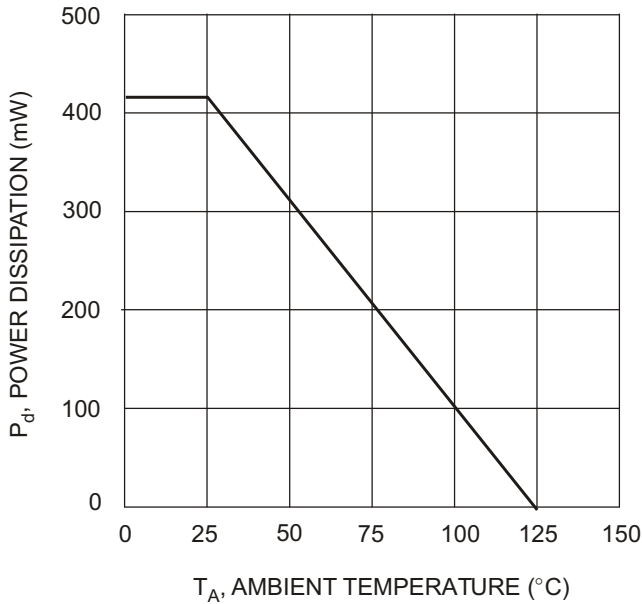


Fig. 1 Power Derating Curve

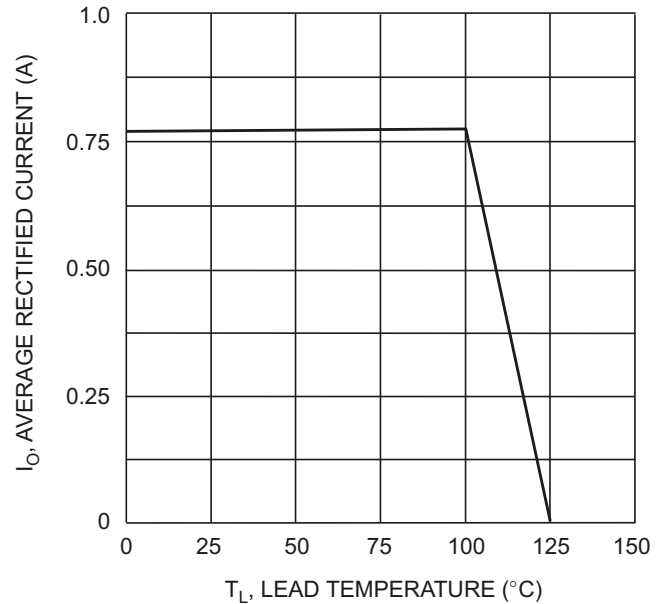


Fig. 2 Forward Current Derating Curve

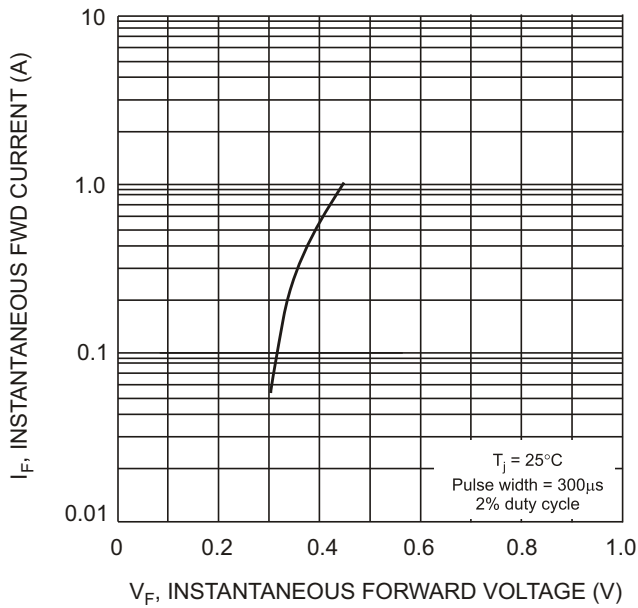


Fig. 3 Typical Forward Characteristics

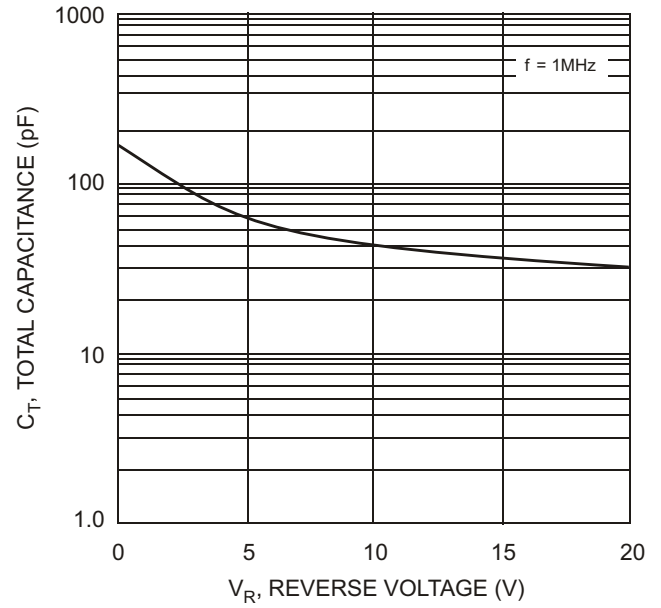


Fig. 4 Typ. Total Capacitance vs Reverse Voltage

TYPICAL TRANSIENT CHARACTERISTICS

B0540W

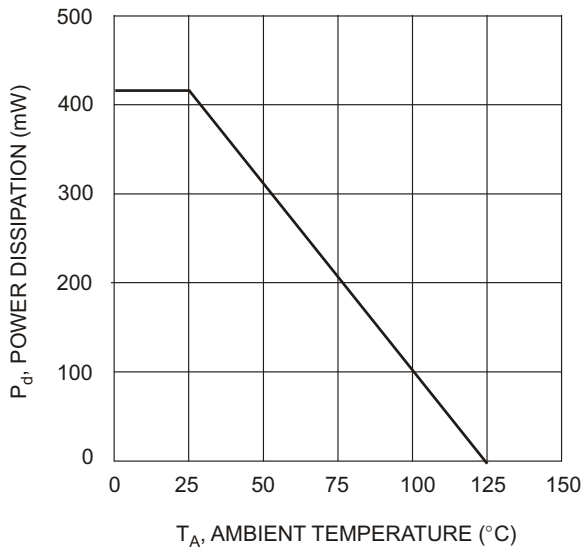


Fig. 1 Power Derating Curve

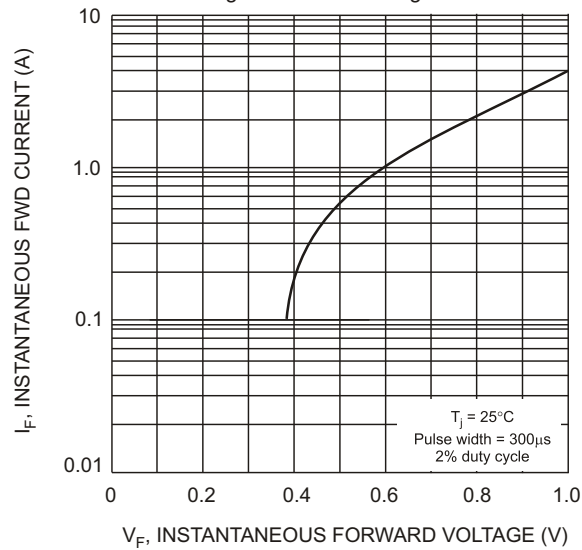


Fig. 3 Typical Forward Characteristics

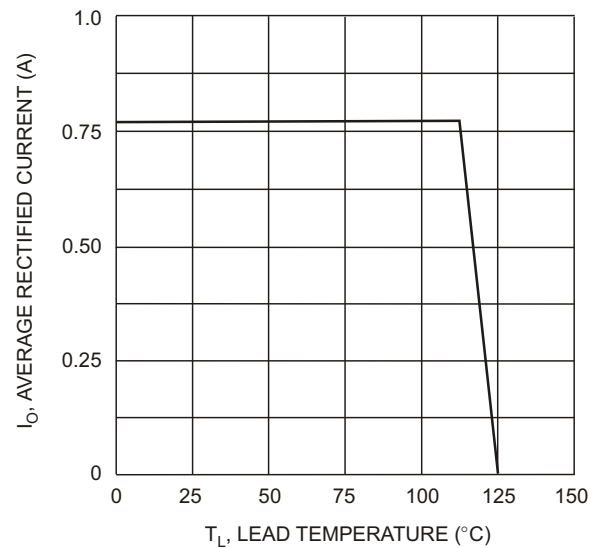


Fig. 2 Forward Current Derating Curve

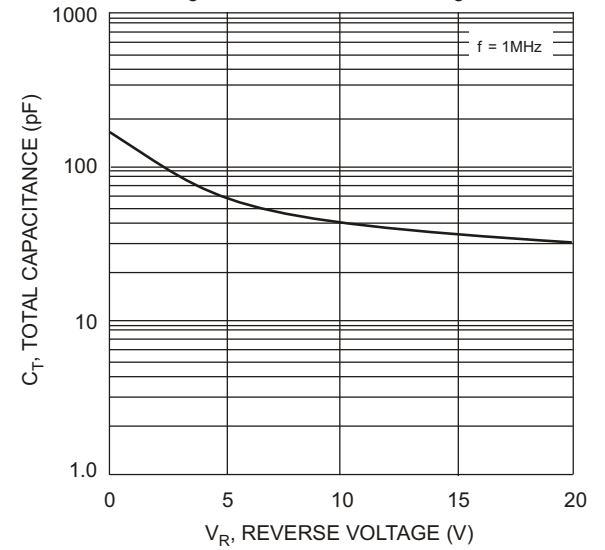


Fig. 4 Typ. Total Capacitance vs Reverse Voltage

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